

# RMLV0408E Series

4Mb Advanced LPSRAM (512-kword × 8-bit)

R10DS0206EJ0200  
Rev.2.00  
2016.1.12

## Description

The RMLV0408E Series is a family of 4-Mbit static RAMs organized 524,288-word × 8-bit, fabricated by Renesas's high-performance Advanced LPSRAM technologies. The RMLV0408E Series has realized higher density, higher performance and low power consumption. The RMLV0408E Series offers low power standby power dissipation; therefore, it is suitable for battery backup systems. It is offered in 32-pin SOP, 32-pin TSOP (II) or 32-pin sTSOP.

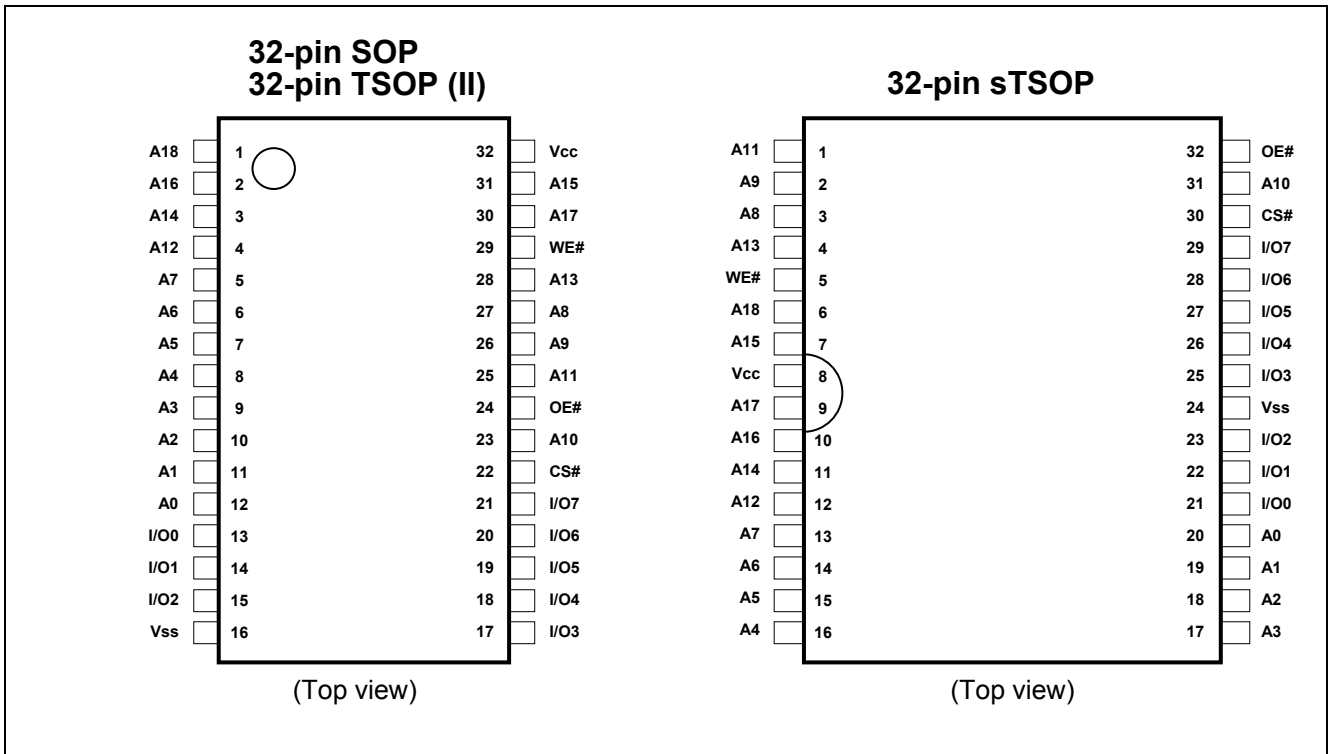
## Features

- Single 3V supply: 2.7V to 3.6V
- Access time: 45ns (max.)
- Current consumption:
  - Standby: 0.4μA (typ.)
- Equal access and cycle times
- Common data input and output
  - Three state output
- Directly TTL compatible
  - All inputs and outputs
- Battery backup operation

## Orderable part number information

Orderable part number	Access time	Temperature range	Package	Shipping container
RMLV0408EGSA-4S2#AA*	45 ns	-40 ~ +85°C	8mm×13.4mm 32-pin plastic sTSOP	Tray
RMLV0408EGSA-4S2#KA*				Embossed tape
RMLV0408EGSB-4S2#AA*			400-mil 32pin plastic TSOP (II)	Tray
RMLV0408EGSB-4S2#HA*				Embossed tape
RMLV0408EGSP-4S2#CA*			525-mil 32-pin plastic SOP	Tube
RMLV0408EGSP-4S2#HA*				Embossed tape

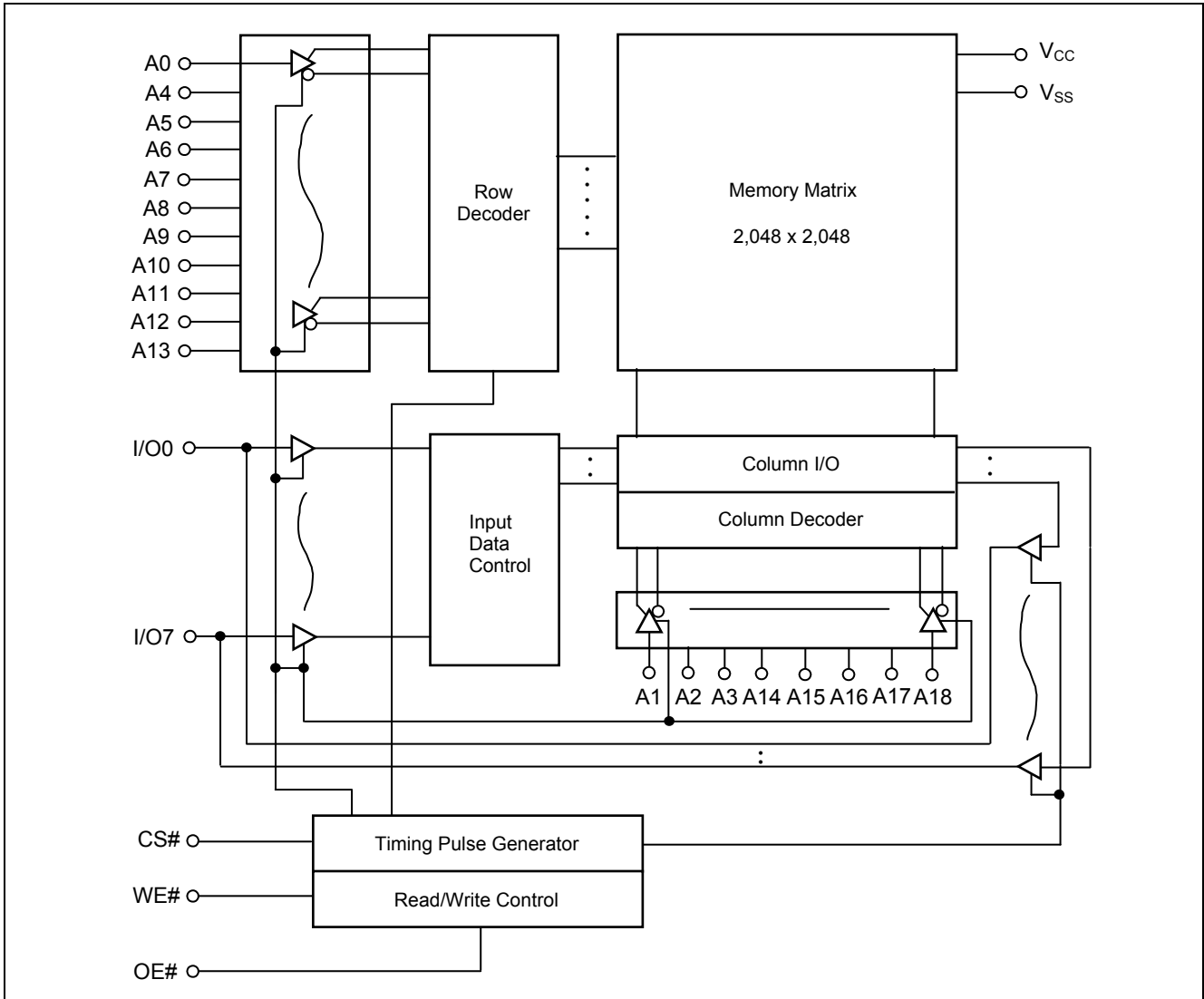
Pin Arrangement



Pin Description

Pin name	Function
V <sub>CC</sub>	Power supply
V <sub>SS</sub>	Ground
A0 to A18	Address input
I/O0 to I/O7	Data input/output
CS#	Chip select
WE#	Write enable
OE#	Output enable

### Block Diagram



### Operation Table

CS#	WE#	OE#	I/O0 to I/O7	Operation
H	X	X	High-Z	Standby
L	H	L	Dout	Read
L	L	X	Din	Write
L	H	H	High-Z	Output disable

Note 1. H:  $V_{IH}$  L:  $V_{IL}$  X:  $V_{IH}$  or  $V_{IL}$

### Absolute Maximum Ratings

Parameter	Symbol	Value	unit
Power supply voltage relative to $V_{SS}$	$V_{CC}$	-0.5 to +4.6	V
Terminal voltage on any pin relative to $V_{SS}$	$V_T$	$-0.5^2$ to $V_{CC}+0.3^3$	V
Power dissipation	$P_T$	0.7	W
Operation temperature	$T_{opr}$	-40 to +85	°C
Storage temperature range	$T_{stg}$	-65 to +150	°C
Storage temperature range under bias	$T_{bias}$	-40 to +85	°C

Note 2. -3.0V for pulse  $\leq 30$ ns (full width at half maximum)

3. Maximum voltage is +4.6V.

## DC Operating Conditions

Parameter	Symbol	Min.	Typ.	Max.	Unit	Note
Supply voltage	$V_{CC}$	2.7	3.0	3.6	V	
	$V_{SS}$	0	0	0	V	
Input high voltage	$V_{IH}$	2.2	—	$V_{CC}+0.3$	V	
Input low voltage	$V_{IL}$	-0.3	—	0.6	V	4
Ambient temperature range	$T_a$	-40	—	+85	°C	

Note 4. -3.0V for pulse  $\leq 30$ ns (full width at half maximum)

## DC Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions	
Input leakage current	$ I_{LI} $	—	—	1	$\mu$ A	$V_{in} = V_{SS} \text{ to } V_{CC}$	
Output leakage current	$ I_{LO} $	—	—	1	$\mu$ A	$CS\# = V_{IH} \text{ or } OE\# = V_{IH} \text{ or } WE\# = V_{IL}$ , $V_{I/O} = V_{SS} \text{ to } V_{CC}$	
Operating current	$I_{CC}$	—	—	10	mA	$CS\# = V_{IL}$ , Others = $V_{IH}/V_{IL}$ , $I_{I/O} = 0$ mA	
Average operating current	$I_{CC1}$	—	—	20	mA	Cycle = 55ns, duty = 100%, $I_{I/O} = 0$ mA, $CS\# = V_{IL}$ , Others = $V_{IH}/V_{IL}$	
		—	—	25	mA	Cycle = 45ns, duty = 100%, $I_{I/O} = 0$ mA, $CS\# = V_{IL}$ , Others = $V_{IH}/V_{IL}$	
	$I_{CC2}$	—	—	2.5	mA	Cycle = 1 $\mu$ s, duty = 100%, $I_{I/O} = 0$ mA, $CS\# \leq 0.2$ V, $V_{IH} \geq V_{CC}-0.2$ V, $V_{IL} \leq 0.2$ V	
Standby current	$I_{SB}$	—	0.1 <sup>*5</sup>	0.3	mA	$CS\# = V_{IH}$ , Others = $V_{SS} \text{ to } V_{CC}$	
Standby current	$I_{SB1}$	—	0.4 <sup>*5</sup>	2	$\mu$ A	~+25°C	$V_{in} = V_{SS} \text{ to } V_{CC}$ , $CS\# \geq V_{CC}-0.2$ V
		—	—	3	$\mu$ A	~+40°C	
		—	—	5	$\mu$ A	~+70°C	
		—	—	7	$\mu$ A	~+85°C	
Output high voltage	$V_{OH}$	2.4	—	—	V	$I_{OH} = -1$ mA	
	$V_{OH2}$	$V_{CC}-0.2$	—	—	V	$I_{OH} = -0.1$ mA	
Output low voltage	$V_{OL}$	—	—	0.4	V	$I_{OL} = 2.1$ mA	
	$V_{OL2}$	—	—	0.2	V	$I_{OL} = 0.1$ mA	

Note 5. Typical parameter indicates the value for the center of distribution at 3.0V ( $T_a=25^\circ\text{C}$ ), and not 100% tested.

## Capacitance

( $V_{CC} = 2.7\text{V} \sim 3.6\text{V}$ ,  $f = 1\text{MHz}$ ,  $T_a = -40 \sim +85^\circ\text{C}$ )

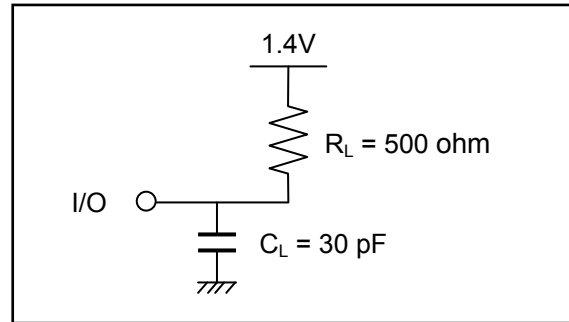
Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions	Note
Input capacitance	$C_{in}$	—	—	8	pF	$V_{in} = 0$ V	6
Input / output capacitance	$C_{I/O}$	—	—	10	pF	$V_{I/O} = 0$ V	6

Note 6. This parameter is sampled and not 100% tested.

## AC Characteristics

Test Conditions ( $V_{CC} = 2.7V \sim 3.6V$ ,  $T_a = -40 \sim +85^{\circ}C$ )

- Input pulse levels:  $V_{IL} = 0.4V$ ,  $V_{IH} = 2.4V$
- Input rise and fall time: 5ns
- Input and output timing reference level: 1.4V
- Output load: See figures (Including scope and jig)



### Read Cycle

Parameter	Symbol	Min.	Max.	Unit	Note
Read cycle time	$t_{RC}$	45	—	ns	
Address access time	$t_{AA}$	—	45	ns	
Chip select access time	$t_{ACS}$	—	45	ns	
Output enable to output valid	$t_{OE}$	—	22	ns	
Output hold from address change	$t_{OH}$	10	—	ns	
Chip select to output in low-Z	$t_{CLZ}$	10	—	ns	7,8
Output enable to output in low-Z	$t_{OLZ}$	5	—	ns	7,8
Chip deselect to output in high-Z	$t_{CHZ}$	0	18	ns	7,8,9
Output disable to output in high-Z	$t_{OHZ}$	0	18	ns	7,8,9

### Write Cycle

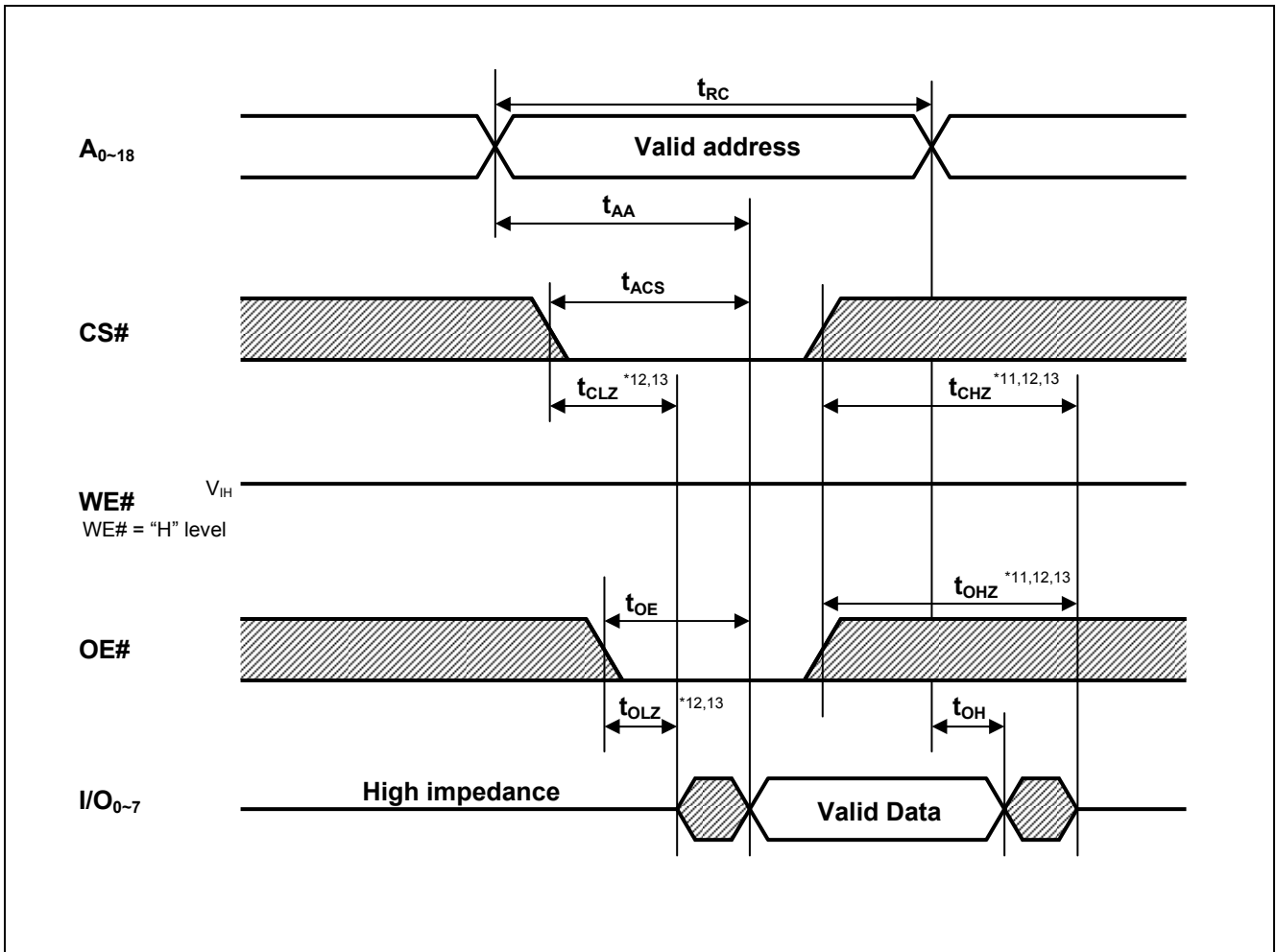
Parameter	Symbol	Min.	Max.	Unit	Note
Write cycle time	$t_{WC}$	45	—	ns	
Address valid to write end	$t_{AW}$	35	—	ns	
Chip select to write end	$t_{CW}$	35	—	ns	
Write pulse width	$t_{WP}$	35	—	ns	10
Address setup time to write start	$t_{AS}$	0	—	ns	
Write recovery time from write end	$t_{WR}$	0	—	ns	
Data to write time overlap	$t_{DW}$	25	—	ns	
Data hold from write end	$t_{DH}$	0	—	ns	
Output enable from write end	$t_{OW}$	5	—	ns	7
Output disable to output in high-Z	$t_{OHZ}$	0	18	ns	7,9
Write to output in high-Z	$t_{WHZ}$	0	18	ns	7,9

Note 7. This parameter is sampled and not 100% tested.

- At any given temperature and voltage condition,  $t_{CHZ}$  max is less than  $t_{CLZ}$  min, and  $t_{OHZ}$  max is less than  $t_{OLZ}$  min, for any device.
- $t_{CHZ}$ ,  $t_{OHZ}$  and  $t_{WHZ}$  are defined as the time when the I/O pins enter a high-impedance state and are not referred to the I/O levels.
- $t_{WP}$  is the interval between write start and write end.  
A write starts when both of CS# and WE# become active  
A write is performed during the overlap of a low CS#, a low WE#  
A write ends when any of CS#, WE# becomes inactive.

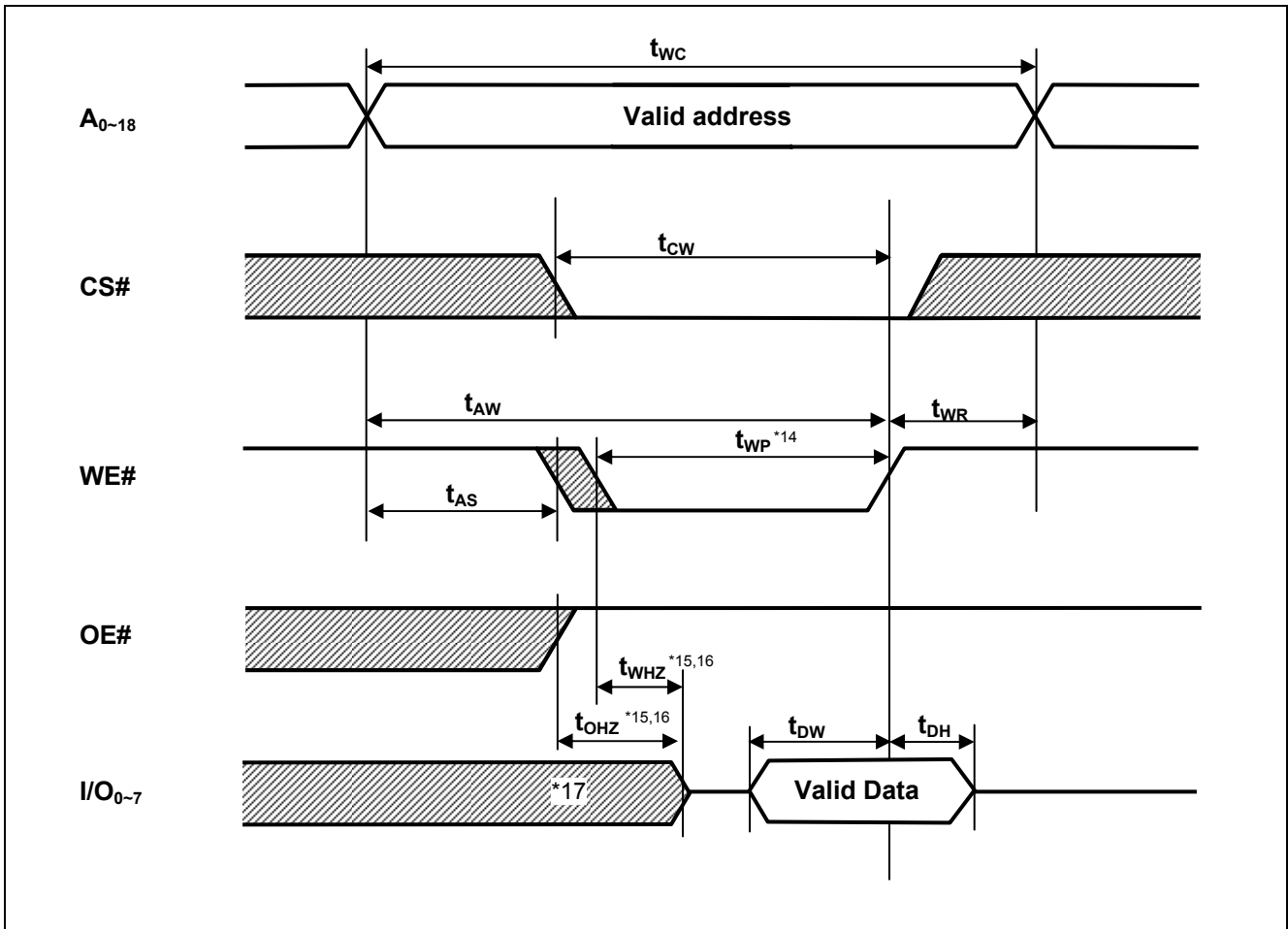
## Timing Waveforms

### Read Cycle



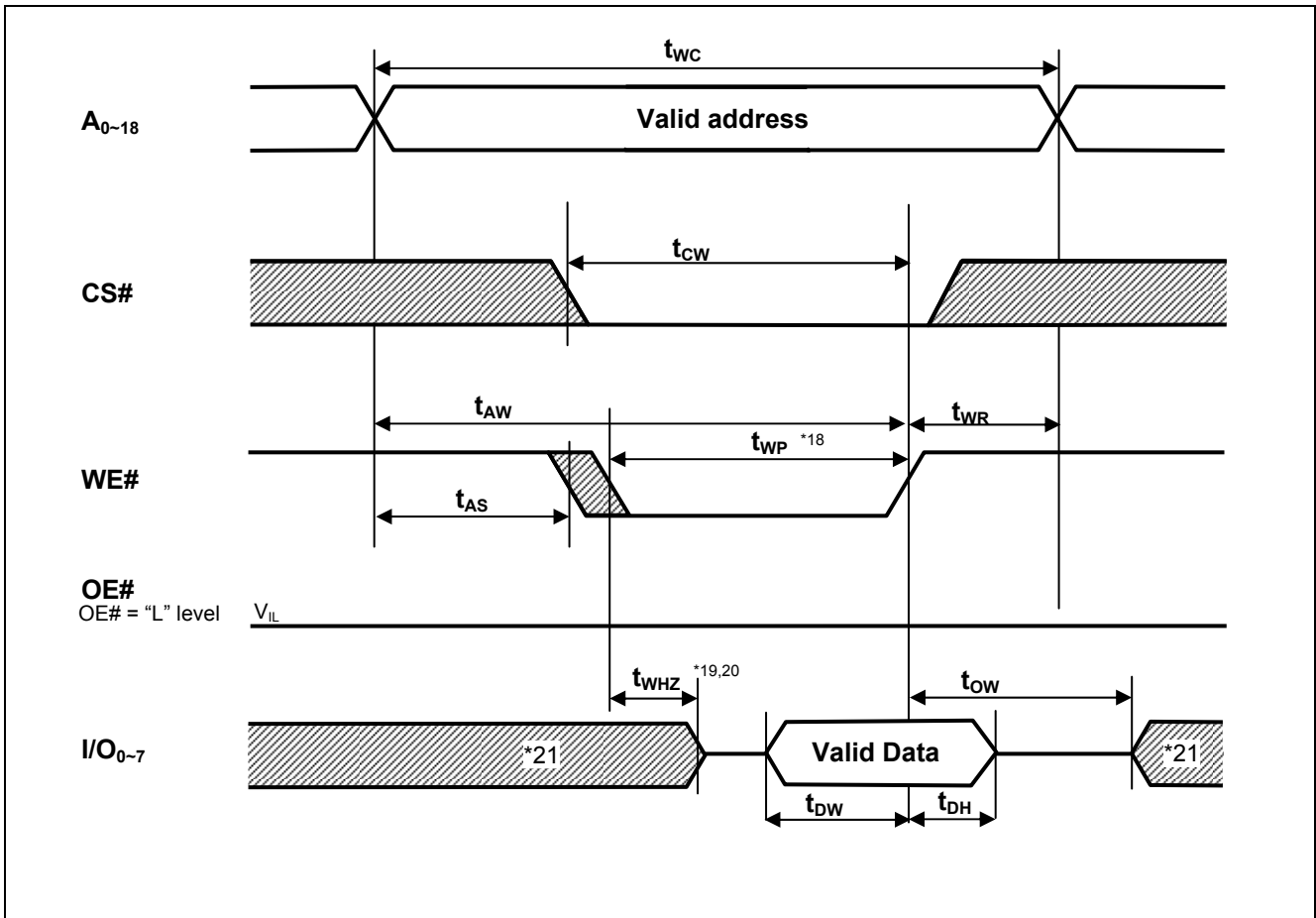
- Note
11.  $t_{CHZ}$  and  $t_{OHZ}$  are defined as the time when the I/O pins enter a high-impedance state and are not referred to the I/O levels.
  12. This parameter is sampled and not 100% tested.
  13. At any given temperature and voltage condition,  $t_{CHZ}$  max is less than  $t_{CLZ}$  min, and  $t_{OHZ}$  max is less than  $t_{OLZ}$  min, for any device.

Write Cycle (1) (WE# CLOCK, OE#="H" while writing)



- Note 14.  $t_{WP}$  is the interval between write start and write end.  
 A write starts when both of  $CS\#$  and  $WE\#$  become active.  
 A write is performed during the overlap of a low  $CS\#$  and a low  $WE\#$ .  
 A write ends when any of  $CS\#$  or  $WE\#$  becomes inactive.
15.  $t_{OHZ}$  and  $t_{WHZ}$  are defined as the time when the I/O pins enter a high-impedance state and are not referred to the I/O levels.
16. This parameter is sampled and not 100% tested.
17. During this period, I/O pins are in the output state so input signals must not be applied to the I/O pins.

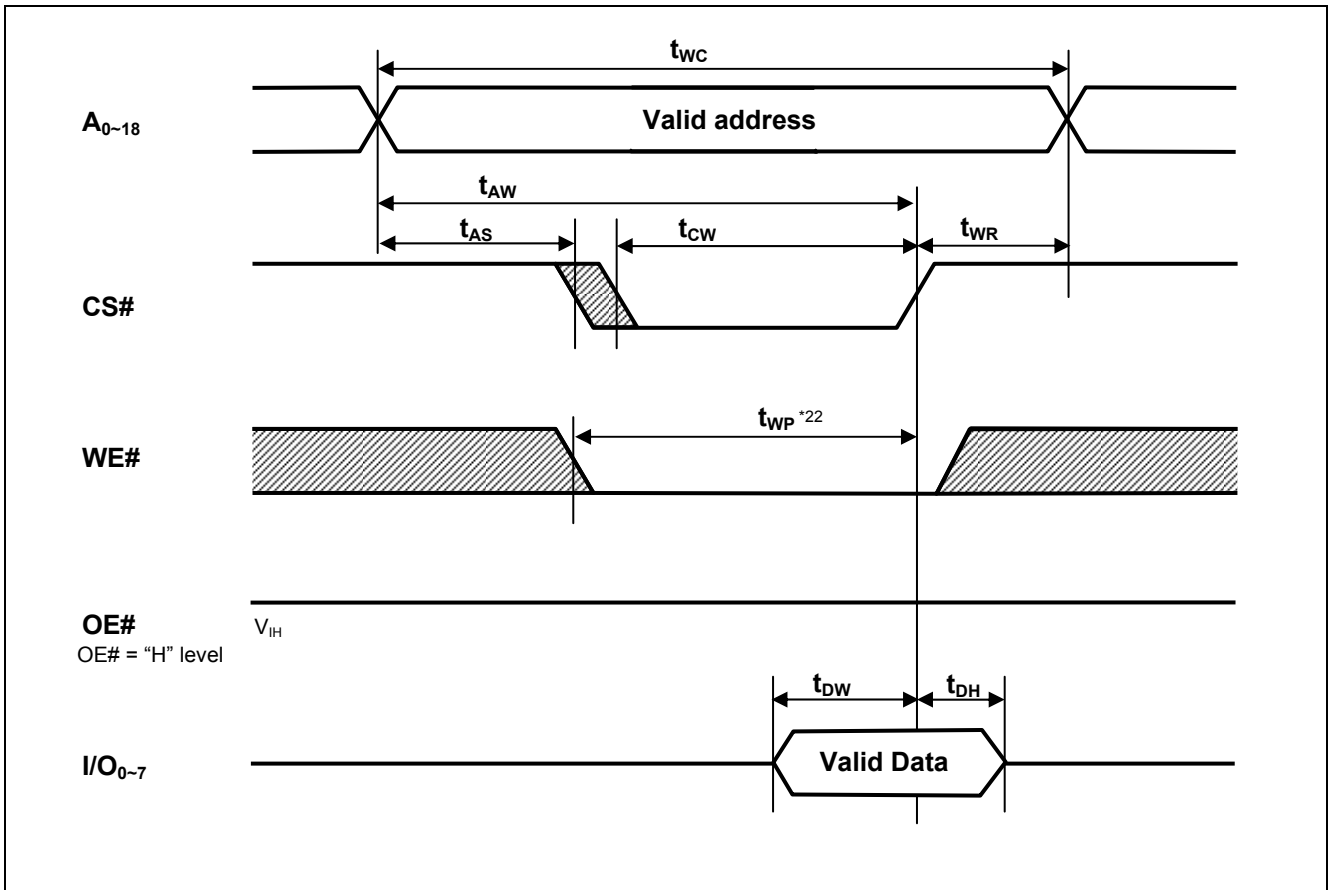
Write Cycle (2) (WE# CLOCK, OE# Low Fixed)



- Note 18.  $t_{WP}$  is the interval between write start and write end.  
 A write starts when both of CS# and WE# become active.  
 A write is performed during the overlap of a low CS# and a low WE#.  
 A write ends when any of CS# or WE# becomes inactive.
19.  $t_{WHZ}$  is defined as the time when the I/O pins enter a high-impedance state and are not referred to the I/O levels.
20. This parameter is sampled and not 100% tested.
21. During this period, I/O pins are in the output state so input signals must not be applied to the I/O pins.



Write Cycle (3) (CS# CLOCK)



Note 22.  $t_{WP}$  is the interval between write start and write end.  
 A write starts when both of CS# and WE# become active.  
 A write is performed during the overlap of a low CS# and a low WE#.  
 A write ends when any of CS# or WE# becomes inactive.

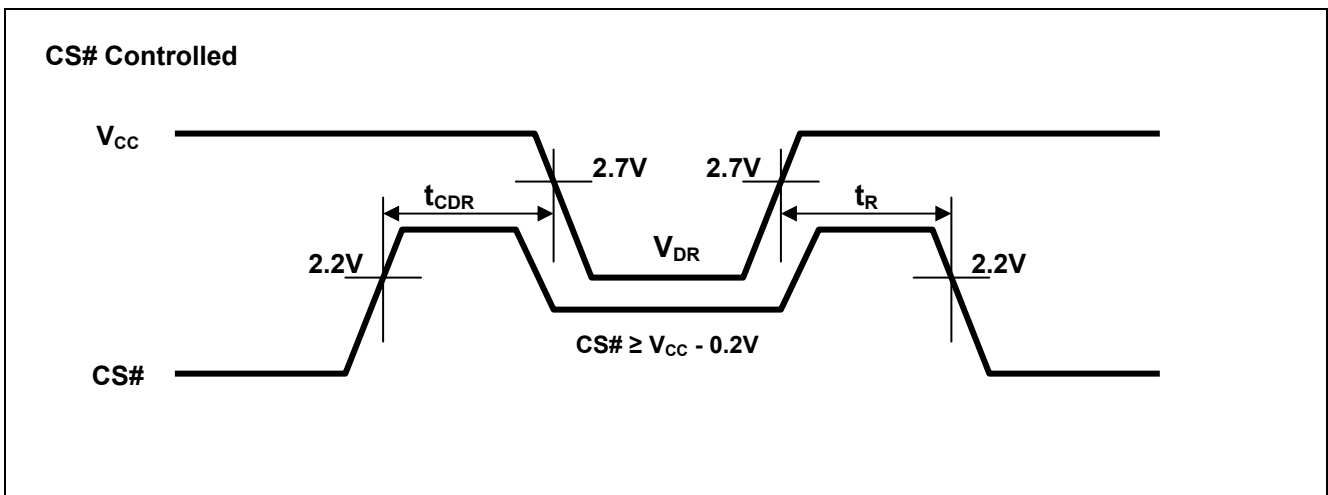
Low V<sub>CC</sub> Data Retention Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions <sup>*24</sup>	
V <sub>CC</sub> for data retention	V <sub>DR</sub>	1.5	—	—	V	V <sub>in</sub> ≥ 0V, CS# ≥ V <sub>CC</sub> -0.2V	
Data retention current	I <sub>CCDR</sub>	—	0.4 <sup>*23</sup>	2	μA	~+25°C	V <sub>CC</sub> =3.0V, V <sub>in</sub> ≥ 0V, CS# ≥ V <sub>CC</sub> -0.2V
		—	—	3	μA	~+40°C	
		—	—	5	μA	~+70°C	
		—	—	7	μA	~+85°C	
Chip deselect time to data retention	t <sub>CDR</sub>	0	—	—	ns	See retention waveform.	
Operation recovery time	t <sub>R</sub>	5	—	—	ms		

Note 23. Typical parameter indicates the value for the center of distribution at 3.0V (T<sub>a</sub>=25°C), and not 100% tested.

24. CS# controls address buffer, WE# buffer, OE# buffer, and I/O buffer. If CS# controls data retention mode, V<sub>in</sub> levels (address, WE#, OE#, I/O) can be in the high-impedance state.

Low V<sub>CC</sub> Data Retention Timing Waveforms (CS# controlled)



Revision History	RMLV0408E Series Data Sheet
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Rev.	Date	Description	
		Page	Summary
1.00	2014.2.27	—	First edition issued
2.00	2016.1.12	1	Changed section from “Part Name Information” to “Orderable part number information”

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